

INDUSTRIAL STRENGTH... Start Your Application From **YOURITECH**

Integration support

Obsolescence Management

Embedded Systems

Human Machine Interface

Touch Solutions

Software

Quality Management

Open Frame Monitors

LCD Controller

Research & Development

Firmware

EMC tests

on-site service

In-house Manufacturing

Cover glass

System solutions

OEM Solutions

Custom Display

PCAP

Mechanical design

Production Custom designs Installation



MODEL NO : ET012FQV05-GTMODEL VERSION: 01SPEC VERSION : 1.0ISSUED DATE: 2018-12-05

- ☒ Preliminary Specification
☐ Final Product Specification

Customer : _____

Approved by	Notes

Table of Contents

Record of Revision.....	3
1 General Specifications	4
2 Input/Output Terminals	5
3 Absolute Maximum Ratings	6
4 Electrical Characteristics.....	6
5 Timing Chart.....	8
6 Optical Characteristics	11
7 Environmental / Reliability Test	14
9 Packing Drawing	16
10 Precautions for Use of LCD Modules	16

1 General Specifications

Feature		Spec
Display Spec.	Size	1.22 inch
	Resolution	240 x RGB x 204
	Technology Type	a-Si
	Pixel Configuration	RGB Vertical Stripe
	Display Mode	Transmission mode, Normally Black
	Viewing Direction	ALL
Mechanical Characteristics	LCM (W x H x D) (mm)	38.84*38.84*2.63
	Active Area(mm)	26.316*30.958
	With /Without CTP	With CTP
	LED Numbers	2 LEDS
	Driver IC	ST7789V
	Weight (g)	TBD
Electrical Characteristics	Interface	SPI
	Color Depth	262K

Note 1: Viewing direction for best image quality is different from TFT definition. There is a 180 degree shift.

Note 2: Requirements on Environmental Protection: Q/S0002

Note 3: LCM weight tolerance: $\pm 5\%$

2 Input/Output Terminals

NO.	PIN NAME	I/O	Description
1	LEDK2	O	LED Cathode
2	LEDK1	O	LED Cathode
3	LEDA	O	LED Anode
4	GND	I	Ground
5	FMARK	O	Tearing effect output pin to synchronies MCU to frame writing, activated by S/W command.
6	SDI	I	Display Data input signal
7	SCLK	I	This pin is used to be serial interface clock
8	RS	I	Register select signal
9	CS	I	Input pin for chip selection signal
10	RESET	I	LCM Reset input signal
11	IOVCC	I	Power Supply 2.8V/1.8V Voltage
12	VCC	I	Power Supply 2.8V Voltage
13	GND	I	Ground

NO.	TP PIN NAME	I/O	Description
1	VCC	I	Power Supply 2.8V Voltage
2	GND	I	Ground
3	SCLK	I	This pin is used to be serial interface clock
4	SDI	I	Display Data input signal
5	GND	I	Ground
6	RESET	I	TP Reset input signal
7	EINT	I	CTP interrupt signals
8	GND	I	Ground
9	NC	NC	NC
10	NC	NC	NC

3 Absolute Maximum Ratings

GND=0V, Ta= 25°C

Item	Symbol	Value	Unit
Power supply voltage for logic	V _{DD}	1.6~3.3	V
Input voltage	V _{in}	V _{DD} +0.3	V
Operating temperature	Topr	-10 to 60	°C
Storage temperature	Tstg	-20 to 60	°C

4 Electrical Characteristics

4.1 Driving TFT LCD Panel

GND=0V, Ta=25°C

Item	Symbol	Min	Type	Max	Unit	Test condition
Operating voltage	V _{DD}	2.6	2.8	3.3	V	-
Supply current	I _{DD}	-	-	5	mA	V _{DD} =2.8V, Ta=25°C
Input voltage	V _{IH}	0.8V _{DD}	-	V _{DD}	V	-
	V _{IL}	0	-	0.2V _{DD}	V	
Input leakage current	I _{IL}	-1.0	-	1.0	μA	V _{IN} =V _{DD} or V _{SS}

Note: Voltage greater than above may damage the module.

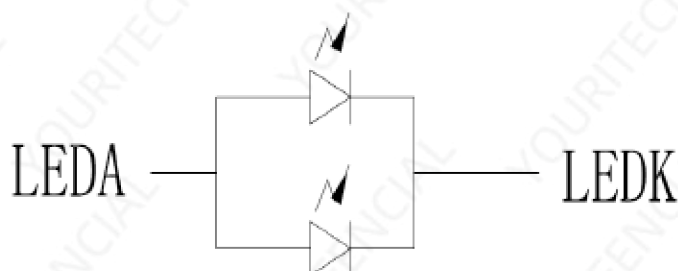
All voltages are specified relative to VSS=0V.

4.2 Backlight Unit

The backlight system is an edge-lighting type with 2 LED. The characteristics of the LED are shown in the following tables.

Item	Symbol	MIN	TYP	MAX	Unit	Remark
Backlight forward voltage	V_F	-	3.2	-	V	2 LEDs
Backlight forward current	I_F	--	40	--	mA	
LED life time	--	20000	--	--	Hrs	

Note 1: LED life time (Hr) can be defined as the time in which it continues to operate under the condition: $T_a=25\pm3\text{ }^{\circ}\text{C}$, typical IL value indicated in the above table and the $f_L=50\text{kHz}$ until the brightness becomes less than 50%.



$I_F=40\text{mA}$, $V_F=3.2\text{V (TYP)}$

5 Timing Chart

5.1 Reset Timing Characteristics.

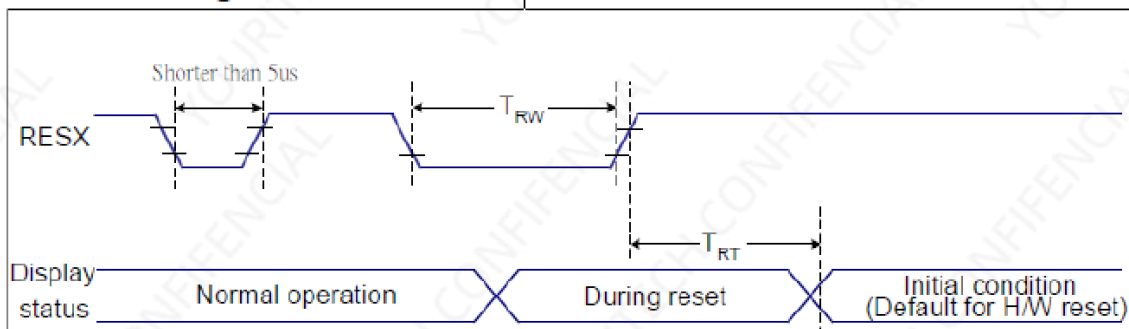


Figure 7 Reset Timing

$V_{DD1}=1.65$ to $3.3V$, $V_{DD}=2.4$ to $3.3V$, $AGND=DGND=0V$, $T_a=25^{\circ}C$

Related Pins	Symbol	Parameter	MIN	MAX	Unit
RESX	TRW	Reset pulse duration	10	-	us
	TRT	Reset cancel	-	5 (Note 1, 5)	ms
				120 (Note 1, 6, 7)	ms

Table 9 Reset Timing

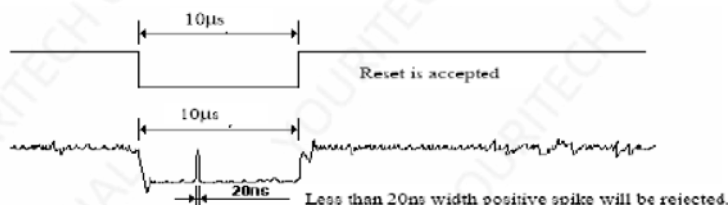
Notes:

1. The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NVM (or similar device) to registers. This loading is done every time when there is HW reset cancel time (t_{RT}) within 5 ms after a rising edge of RESX.
2. Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below:

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 9us	Reset
Between 5us and 9us	Reset starts

3. During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode.) and then return to Default condition for Hardware Reset.

4. Spike Rejection also applies during a valid reset pulse as shown below:



5. When Reset applied during Sleep In Mode.
6. When Reset applied during Sleep Out Mode.
7. It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

The information contained herein is the exclusive property of Shenzhen Youri Technology Co.,Ltd, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of Shenzhen Youri Technology Co.,Ltd

5.2 Serial Interface Characteristics(3-line serial).

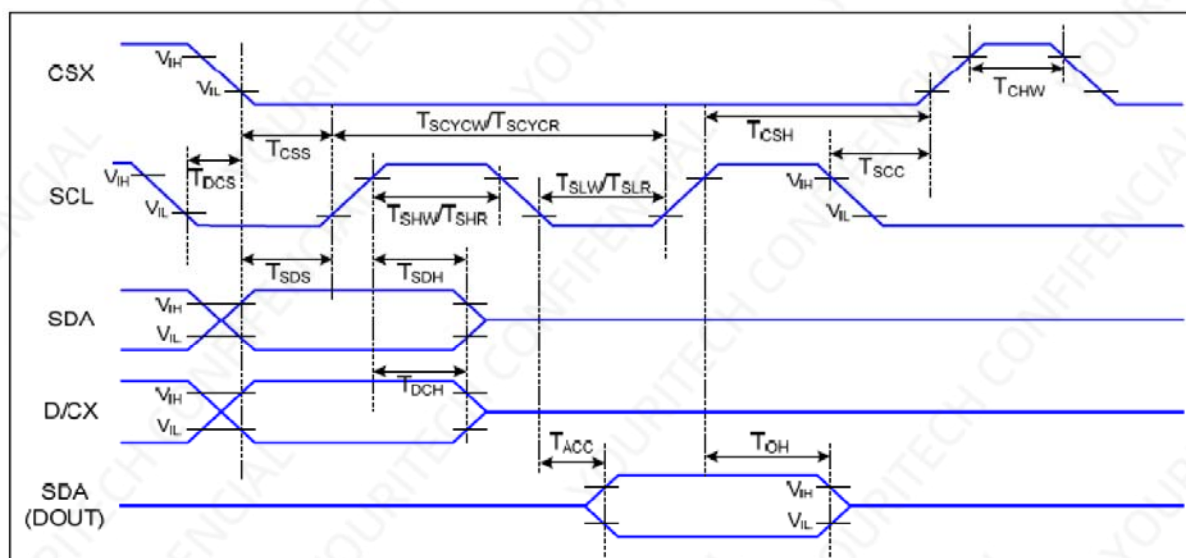


Figure 7 4-line Serial Interface Timing

T_a=25 °C, VDDI=1.65~3.7V, VDD=2.5~4.8V

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
CSX	TCSS	Chip Select Setup Time (Write)	45		ns	
	TCSH	Chip Select Hold Time (Write)	45		ns	
	TCSS	Chip Select Setup Time (Read)	60		ns	
	TSCC	Chip Select Hold Time (Read)	65		ns	
	TCHW	Chip Select "H" Pulse Width	40		ns	
SCL	TSCYCW	Serial Clock Cycle (Write)	66		ns	-Write Command & Data Ram
	TSHW	SCL "H" Pulse Width (Write)	15		ns	
	TSLW	SCL "L" Pulse Width (Write)	15		ns	
	TSCYCR	Serial Clock Cycle (Read)	150		ns	-Read Command & Data Ram
	TSHR	SCL "H" Pulse Width (Read)	60		ns	
	TSLR	SCL "L" Pulse Width (Read)	60		ns	
D/CX	TDCS	D/CX Setup Time	10		ns	
	TDCH	D/CX Hold Time	10		ns	
SDA (DIN) (DOUT)	TSDS	Data Setup Time	10		ns	For Maximum CL=30pF For Minimum CL=8pF
	TSDH	Data Hold Time	10		ns	
	TACC	Access Time	10	50	ns	
	TOH	Output Disable Time	15	50	ns	

Table 7 4-line Serial Interface Characteristics

Note : The rising time and falling time (Tr, Tf) of input signal are specified at 15 ns or less. Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

5.3 Power ON/OFF Sequence

VDDI and VDD can be applied in any order

VDD and VDDI can be powered down in any order

During power off, if LCD is in the Sleep Out mode, VDD and VDDI must be powered down minimum 120msec after RESX has been released.

During power off, if LCD is in the Sleep In mode, VDDI or VDD can be powered down minimum 0msec after RESX has been released.

CSX can be applied at any timing or can be permanently grounded. RESX has priority over CSX.

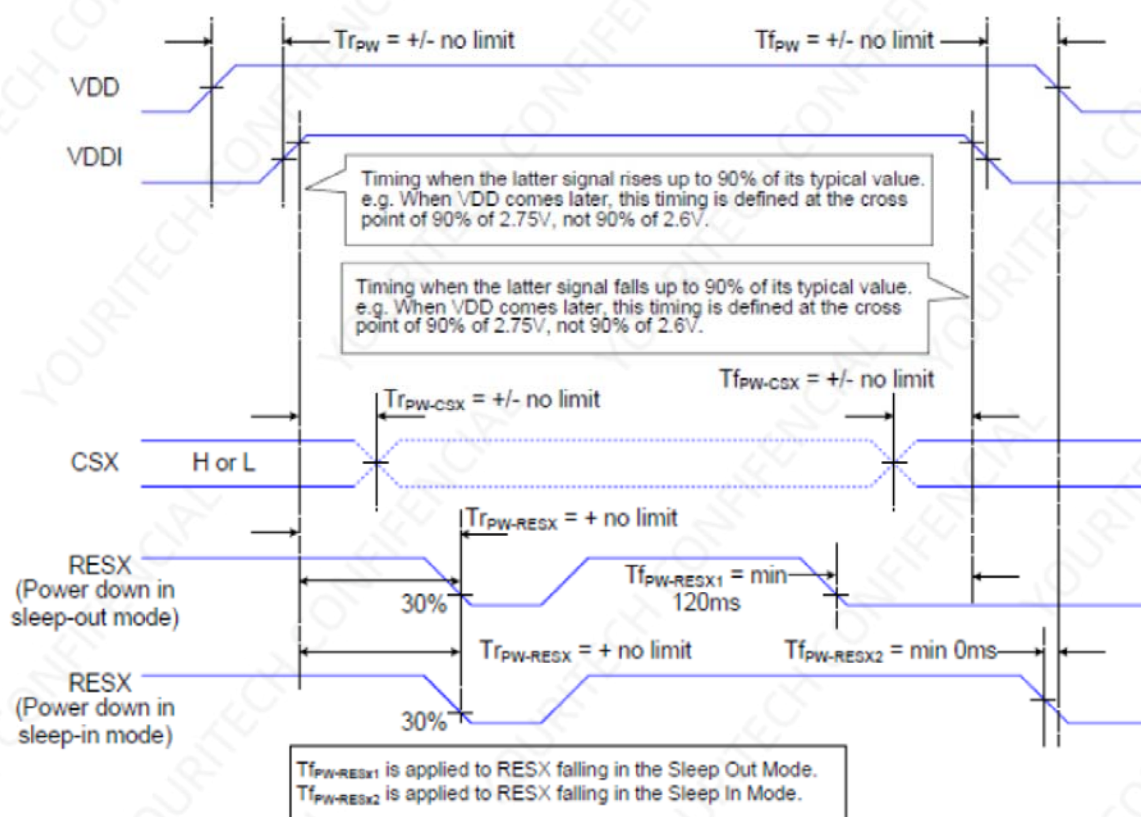
Note 1: There will be no damage to the display module if the power sequences are not met.

Note 2: There will be no abnormal visible effects on the display panel during the Power On/Off Sequences.

Note 3: There will be no abnormal visible effects on the display between end of Power On Sequence and before receiving Sleep Out command. Also between receiving Sleep In command and Power Off Sequence.

Note 4: If RESX line is not held stable by host during Power On Sequence as defined in the sequence below, then it will be necessary to apply a Hardware Reset (RESX) after Host Power On Sequence is complete to ensure correct operation. Otherwise function is not guaranteed.

The power on/off sequence is illustrated below



6 Optical Characteristics

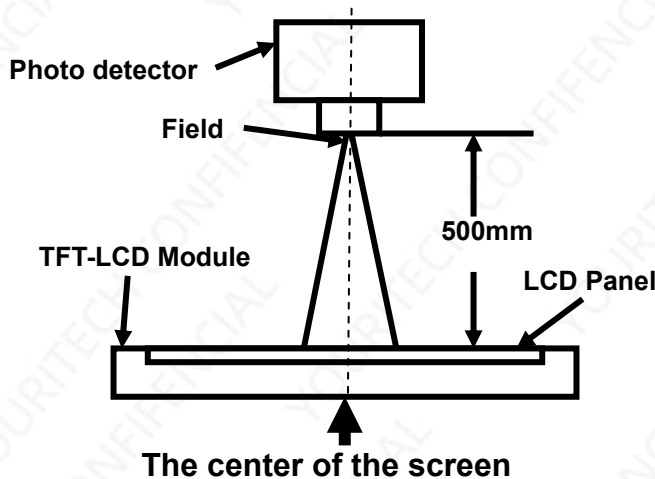
Item		Symbol	Condition	Min	Typ	Max	Unit	Remark
View Angles		θT	CR≥ 10	-	80	-	Degree	Note2,3
		θB		-	80	-		
		θL		-	80	-		
		θR		-	80	-		
Contrast Ratio		CR	θ=0°	600	700	-		Note 3
Response Time		T _{ON}	25℃	-	30	-	ms	Note 4
		T _{OFF}						
Chromaticity	White	x	Backlight is on	0.253	0.303	0.353		Note 1,5
		y		0.278	0.328	0.378		
	Red	x						Note 1,5
		y						
	Green	x						Note 1,5
		y						
	Blue	x						Note 1,5
		y						
Uniformity		U		75	80	--	%	Note 6
Luminance		L		280	300	-	cd/m ²	Note 7

Test Conditions:

1. $I_F = 20$ mA, and the ambient temperature is 25℃.
2. The test systems refer to Note 1 and Note 2.

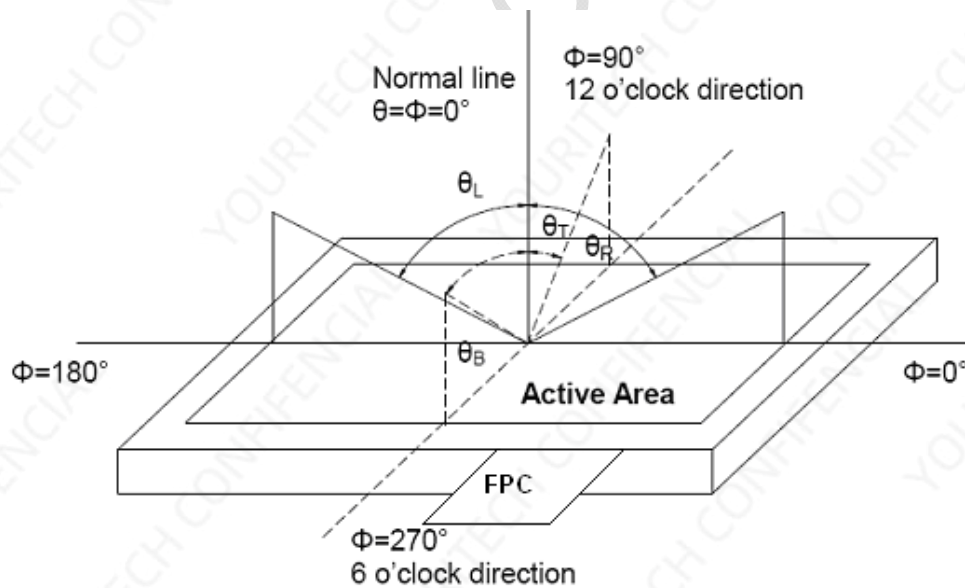
Note 1: Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 5 Minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when measuring the center area of the panel.



Note 2: Definition of viewing angle range and measurement system.

viewing angle is measured at the center point of the LCD.



Note 3: Definition of contrast ratio

$$\text{Contrast ratio (CR)} = \frac{\text{Luminance measured when LCD is on the "White" state}}{\text{Luminance measured when LCD is on the "Black" state}}$$

"White state ": The state is that the LCD should drive by V_{white} .

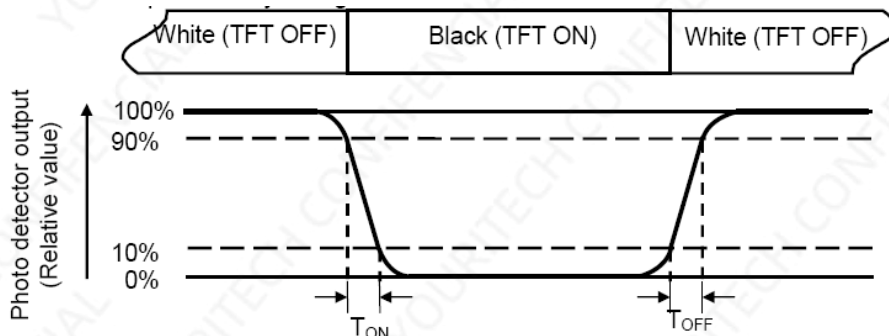
"Black state": The state is that the LCD should drive by V_{black} .

V_{white} : To be determined V_{black} : To be determined.

The information contained herein is the exclusive property of Shenzhen Youri Technology Co.,Ltd, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of Shenzhen Youri Technology Co.,Ltd

Note 4: Definition of Response time

The response time is defined as the LCD optical switching time interval between “White” state and “Black” state. Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%.



Note 5: Definition of color chromaticity (CIE1931)

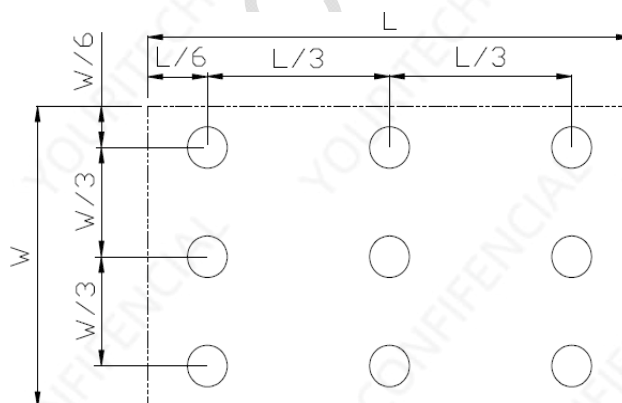
Color coordinates measured at center point of LCD.

Note 6: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

$$\text{Luminance Uniformity (U)} = L_{\min} / L_{\max}$$

L-----Active area length W----- Active area width



$L_{\max}$: The measured Maximum luminance of all measurement position.

$L_{\min}$: The measured Minimum luminance of all measurement position.

Note 7: Definition of Luminance:

Measure the luminance of white state at center point.

7 Environmental / Reliability Test

No	Test Item	Condition	Remarks
1	High Temperature Operation	70℃, 120Hours	IEC60068-2-1:2007 GB2423.2-2008
2	Low Temperature Operation	-20℃, 120 Hours	IEC60068-2-1:2007 GB2423.1-2008
3	High Temperature Storage	80℃, 200 Hours	IEC60068-2-1:2007 GB2423.2-2008
4	Low Temperature Storage	-30℃, 200 Hours	IEC60068-2-1:2007 GB2423.1-2008
5	Storage at High Temperature and Humidity	40℃, 90%RH, 120 Hours	IEC60068-2-78 :2001 GB/T2423.3—2006
6	Thermal Shock (non-operation)	-10℃, 30min.<=> 60℃, 30min. 10 Cycles	Start with cold temperature, End with high temperature, IEC60068-2-14:1984,G B2423.22-2002
7	ESD	Voltage:±8KV R:330 ohm,C:150pF Air discharge,10 times	IEC61000-4-2:2001 GB/T17626.2-2006
8	Vibration Test	10 => 55 =>10 => 55 => 10 Hz, within 1 minute;Amplitude:1.5mm. 15 minutes for each Direction (X,Y,Z)	IEC60068-2-6:1982 GB/T2423.10—1995
10	Package Drop Test	Packed, 100CM free fall 6 sides, 1 corner, 3edges	IEC60068-2-32:1990 GB/T2423.8—1995

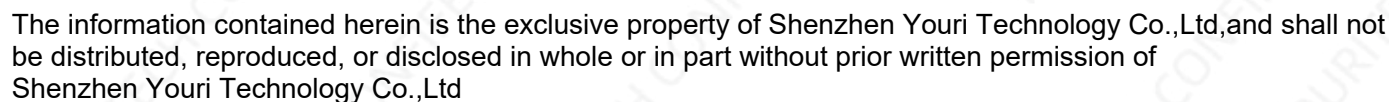
Note1: Ts is the temperature of panel's surface.

Note2: Ta is the ambient temperature of sample.

Note3: Before cosmetic and function test, the product must have enough recovery time, at least 2 hours at room temperature.

Note 4: In the standard condition, there shall be no practical problem that may affect the display function. After the reliability test, the product only guarantees operation, but don't guarantee all of the cosmetic specification.

8.Outline Dimension



9 Packing Drawing

TBD

10 Precautions for Use of LCD Modules

a) Handling Precautions

- i. The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- ii. If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- iii. Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- iv. The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- v. If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
 - Ketone
 - Aromatic solvents
- vi. Do not attempt to disassemble the LCD Module.
 - vii. If the logic circuit power is off, do not apply the input signals.
 - viii. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

10.1.8.1 Be sure to ground the body when handling the LCD Modules.

10.1.8.2 Tools required for assembly, such as soldering irons, must be properly ground.

10.1.8.3 To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.

10.1.8.4 The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

b) Storage precautions

- i. When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.

- ii. The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : 0℃ ~ 40℃ Relatively humidity: ≤80%

- iii. The LCD modules should be stored in the room without acid, alkali and harmful gas.

c) Transportation Precautions

- i. The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.